## UNITED STATES PATENT AND TRADEMARK OFFICE CERTIFICATE OF CORRECTION

PATENT NO. : 7,235,886 B1 APPLICATION NO.: 10/023819

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DATED INVENTOR(S) : June 26, 2007 : Chandran et al.

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

Title page, Item (56), under "Other Publications", in column 2, line 4, delete "TD-291011" and insert -- RD-291011 --, therefor.

Title page, Item (57), under "Abstract", in column 2, line 11, delete "up" and insert -- upon --, therefor.

In column 6, line 17, in Claim 3, delete "clam 1" and insert -- claim 1 --, therefor.

In column 6, line 43, in Claim 7, after "at a" delete "the".

In column 6, line 67, in Claim 12, delete "heat" and insert -- heating --, therefor.

In column 7, line 39, in Claim 17, delete "jointed" and insert -- joined --, therefor.

In column 7, lines 45-46, in Claim 18, after "solder joint." delete "onto a surface of the substrate to form the soldered joint.". (Second Occurrence)

In column 7, line 56 (Approx.), in Claim 19, before "soldered" insert -- of --.

In column 8, line 24 (Approx.), in Claim 22, after "and" insert -- the --.

Signed and Sealed this

Thirtieth Day of October, 2007

JON W. DUDAS Director of the United States Patent and Trademark Office